Name :	
Roll No. :	An Annual (Y Kanadada Jan Kapland

Invigilator's Signature :

CS/B.Tech/CT/SEM-8/CT-801(B)/2013 2013 NON-OXIDE CERAMICS

Time Allotted : 3 Hours

Full Marks : 70

The figures in the margin indicate full marks.

Candidates are required to give their answers in their own words as far as practicable.

GROUP – A

(Multiple Choice Type Questions)

1. Answer any *ten* of the following :

 $10 \times 1 = 10$

- A) Choose the correct alternative for the following :
 - i) Bonding between elements in non-oxide material is predominantly
 - a) electrovalent
 - b) covalent
 - c) metallic.
 - ii) Material decomposes before melting (ambient pressure)
 - a) SiC b) Si $_3$ N $_4$

c) both (a) and (b) d) none of these.

- iii) Synthesis os Si $_3$ N $_4$ is done in oxygen free atmosphere due to preferential reaction between
 - a) O + N
 - b) Si + N
 - c) Si + O.

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- iv) Nitride bonded SiC means bonded b
 - a) AIN
 - b) Si₃N₄
 - c) any nitride.
- v) Non-oxide ceramics are potential engineering material due to their
 - a) hardness
 - b) fracture toughness
 - c) machinability.
- vi) In reaction bonded silicon carbide unreacted element present in the product is
 - a) carbon
 - b) silicon
 - c) none of these.
- vii) Sintering of SiC by B & C aid facilitate
 - a) surface transport
 - b) vapour transport
 - c) grain-boundary diffusion
 - d) volume diffusion.
- viii) Gas pressure sintering of non-oxide ceramics
 - a) increases surface transport
 - b) suppresses grain-boundary diffusion
 - c) suppresses dissociation of compound e.g.SiC/Si $_3$ N $_4$.
- ix) In silicon nitride Si (+4) may be replaced by Al (+3) provided
 - a) Si (+4) replaced by Al (+3)
 - b) Si (+4) and Al (+3) are anions.

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a) fine grain

X)

- b) coarse grain.
- xi) Intricate and complex shapes difficult to achieve by
 - a) pressureless sintering
 - b) hot pressing.
- B) Answer very briefly :
 - xii) Nitridation of silicon to produce silicon nitride is done in two stages-way ?

GROUP – B (Short Answer Type Questions)

Answer any *three* of the following. $3 \times 5 = 15$

- 2. How many polymorphic forms of SiC are known ? State their crystal habits. Which of those forms have polytypes. What is the difference between polymorphism and polytypeism ?
- 3. State general method of preparation of Boron Nitride.
- 4. What is SiAlON ? How is it structurally different from normal silicate ceramics ?
- 5. Give reasons for preferring silicon carbide based kiln furniture over traditional.
- 6. Self bonded silicon carbide show higher tensile strength at higher temperature. Explain.

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- 7. Discuss with a neat flow diagram manufacturing process of clay bonded silicon carbide ceramics. Mention applications of the product.
- Briefly describe various methods of sintering of silicon 8. nitride. Discuss mechanism of liquid phase sintering of $\operatorname{Si}_{3}\operatorname{N}_{4}$.
- What are different methods of synthesis of boron nitride. 9. State some of its applications.
- 10. What are the differences between self bonded and reaction bonded silicon carbide ? Explain how an essentially nonsinterable silicon carbide is made sinterable.
- 11. What are the general methods for preparing oxynitride glass ? What is the thermodynamic parameters to be considered for selecting oxide for preparing oxynitride glass? Propose some of the application potential of the material.

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